

SP4208 series 3.0pF, 30A Discrete TVS Diode







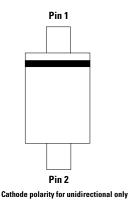




Description

The SP4208 components integrate low capacitance steering diodes with one or two avalanche breakdown diodes for unidirectional or bidirectional protection, respectively, to protect against ESD and lightning induced surge events. These components can safely absorb up to 30A per IEC 61000-4-5 2nd edition (t_n=8/20µs) without performance degradation and a minimum ±30kV ESD per IEC 61000-4-2 International Standard. The low loading capacitance and high surge capability make it ideal for protecting telecommunication ports such as Ethernet and other high speed data interfaces.

Pinout

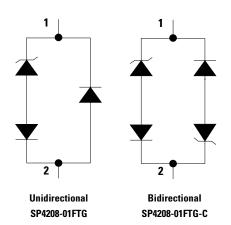


Features

- ESD, IEC 61000-4-2, ±30kV contact, ±30kV air
- EFT, IEC 61000-4-4, 40A (5/50ns)
- Lightning, IEC 61000-4-5 2nd edition, 30A $(t_p = 8/20 \mu s)$
- Low capacitance of 3.0pF (@ V_R=0V)
- Low leakage current

- Unidirectional and bidirectional configuration
- Small SOD323 package fits 0805 footprints
- AEC-Q101 qualified
- Halogen free, lead free and RoHS compliant
- Moisture Sensitivity Level(MSL -1)

Functional Block Diagram



Applications

- •10/100/1000 2.5 and 5 Gigabit Ethernet
- •Medical Equipment
- Computers and Peripherals
- Instrumentation

Life Support Note:

Not Intended for Use in Life Support or Life Saving Applications

The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated.

TVS Diode Arrays (SPA® Diodes) Lightning Surge Protection- SP4208 Series

Absolute Maximum Ratings

Symbol	Parameter	Value	Units
I _{pp}	Peak Current (t _p =8/20µs)	30	А
P_{pk}	Peak Pulse Power (t _p =8/20µs)	750	W
T _{OP}	Operating Temperature	-40 to 125	°C
T _{STOR}	Storage Temperature	-55 to 150	°C

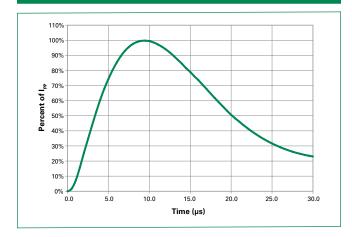
CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the component. This is a stress only rating and operation of the component at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Electrical Characteristics (T_{OP}=25°C)

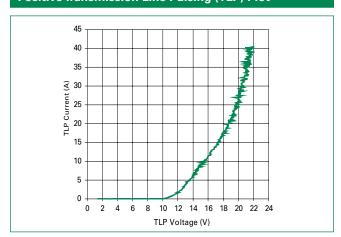
Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Breakdown Voltage	V _{BD}	I _R =1mA	-	9.5	-	V
Reverse Standoff Voltage	V _{RWM}	I _R ≤1μA	-	-	8.0	V
Leakage Current	LEAK	V _R =8.0V	-	0.02	0.5	μΑ
Clamp Voltage _1 $V_{_{\mathbb{C}}}$	$I_{pp}=1A, t_{p}=8/20\mu s, Fwd$	-	11.5	-	V	
	I _{pp} =17A, t _p =8/20μs, Fwd	-	19	-	V	
		I _{pp} =30A, t _p =8/20μs, Fwd	-	25	-	V
Dynamic Resistance ²	R _{DYN}	TLP, tP=100ns, I/O to GND	-	0.37	-	Ω
ESD Withstand Voltage ¹ V _{ESD}	IEC 61000-4-2 (Contact Discharge)	±30	-	-	kV	
	V _{ESD}	IEC 61000-4-2 (Air Discharge)	±30	-	-	kV
Diode Capacitance ¹	C _D	Reverse Bias=0V, f=1MHz	-	3.0	-	pF

1. Parameter is guaranteed by design and/or component characterization.
2. Transmission Line Pulse (TLP) with 100ns width, 2ns rise time, and average window t1=70ns to t2=90ns

8/20µs Pulse Waveform

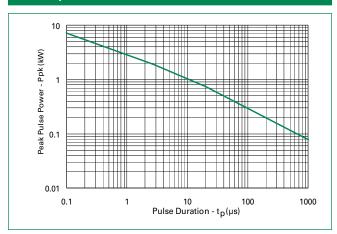


Positive Transmission Line Pulsing (TLP) Plot

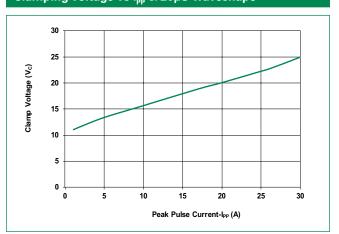




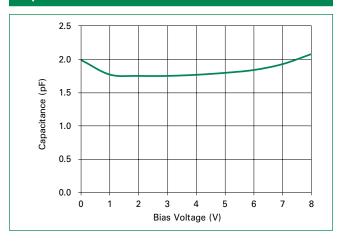
Non-Repetitive Peak Pulse Power vs. Pulse Time



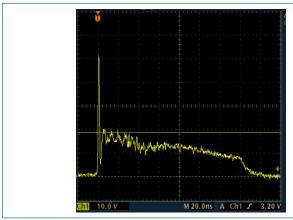
Clamping Voltage vs I_{pp} 8/20µS waveshape



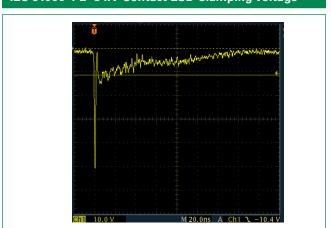
Capacitance vs. Reverse Bias



IEC 61000-4-2 +8 kV Contact ESD Clamping Voltage



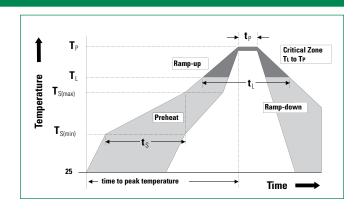
IEC 61000-4-2 -8 kV Contact ESD Clamping Voltage





Soldering Parameters

Reflow Cond	Pb – Free assembly		
Pre Heat	-Temperature Min (T _{s(min)})	150°C	
	-Temperature Max (T _{s(max)})	200°C	
	-Time (min to max) (t _s)	60 – 180 secs	
Average ram	np up rate (Liquidus) Temp (T_L) to peak	3°C/second max	
T _{S(max)} to T _L - Ramp-up Rate		3°C/second max	
Reflow	-Temperature (T _L) (Liquidus)	217°C	
	-Temperature (t _L)	60 – 150 seconds	
Peak Temperature (T _p)		260+0/-5 °C	
Time within 5°C of actual peak Temperature (t _p)		20 - 40 seconds	
Ramp-down Rate		6°C/second max	
Time 25°C to peak Temperature (T _p)		8 minutes Max.	
Do not exceed		260°C	



Product Characteristics

Lead Plating	Matte Tin	
Lead Material	Iron Alloy	
Lead Coplanarity	0.004 inches(0.102mm)	
Substrate material	Silicon	
Body Material	Molded Compound	
Flammability	UL Recognized compound meeting flammability rating V-0	

- All dimensions are in millimeters
 Dimensions include solder plating.
 Dimensions are exclusive of mold flash & metal burr.

Part Marking System



A= Part Code X= Assembly Site

Y= Date Code

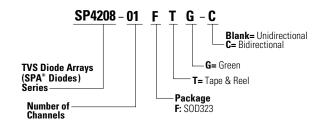
SP4208-01FTG-C



B= Part Code X= Assembly Site

Y= Date Code

Part Numbering System

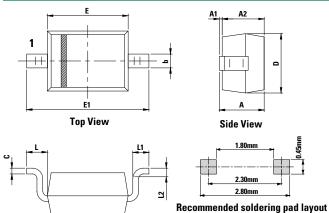


Ordering Information

Part Number	Package	Marking	Min. Order Qty.
SP4208-01FTG	SOD323	Axx	3000
SP4208-01FTG-C	SOD323	Bxx	3000

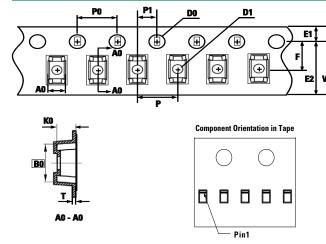


Package Dimensions -SOD323



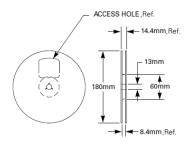
Symbol	Millimeters			
	Min	Nor	Max	
Α	0.80	1.00	1.14	
A1	0	-	0.10	
A2	0.80	0.95	1.04	
b	0.25	0.30	0.35	
С	0.08	-	0.15	
D	1.15	1.30	1.45	
E	1.60	1.75	1.90	
E1	2.44	2.55	2.75	
L	0.475 REF			
L1	0.22	0.35	0.45	
L2	0.20 BSC			

Embossed Carrier Tape & Reel Specification — SOD323



Symbol	Millimeters
A0	1.46+/-0.10
В0	2.90+/-0.10
W	8.0+0.3/-0.10
D0	1.50+0.10
D1	0.45min/1.15max
E1	1.75+/-0.10
E2	-
F	3.50+/-0.10
P0	4.00+/-0.10
Р	4.00+/-0.10
P1	2.00+/-0.05
K0	1.25+/-0.10
T	0.254+/-0.02

8mm TAPE AND REEL



X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for ESD Suppressors / TVS Diodes category:

Click to view products by Littelfuse manufacturer:

Other Similar products are found below:

60KS200C D12V0H1U2WS-7 D18V0L1B2LP-7B 82356050220 D5V0M5U6V-7 NTE4902 P4KE27CA P6KE11CA P6KE39CA-TP
P6KE8.2A SA110CA SA60CA SA64CA SMBJ12CATR SMBJ8.0A SMLJ30CA-TP ESD112-B1-02EL E6327
ESD119B1W01005E6327XTSA1 ESD5V0J4-TP ESD5V0L1B02VH6327XTSA1 ESD7451N2T5G 19180-510 CPDT-5V0USP-HF
3.0SMCJ33CA-F 3.0SMCJ36A-F HSPC16701B02TP D3V3Q1B2DLP3-7 D55V0M1B2WS-7 DESD5V0U1BL-7B DRTR5V0U4SL-7
SCM1293A-04SO ESD203-B1-02EL E6327 SM12-7 SMF8.0A-TP SMLJ45CA-TP CEN955 W/DATA 82350120560 82356240030
VESD12A1A-HD1-GS08 CPDUR5V0R-HF CPDUR24V-HF CPDQC5V0U-HF CPDQC5V0USP-HF CPDQC5V0-HF D1213A-01LP4-7B
D1213A-02WL-7 ESDLIN1524BJ-HQ 5KP100A 5KP15A 5KP18A